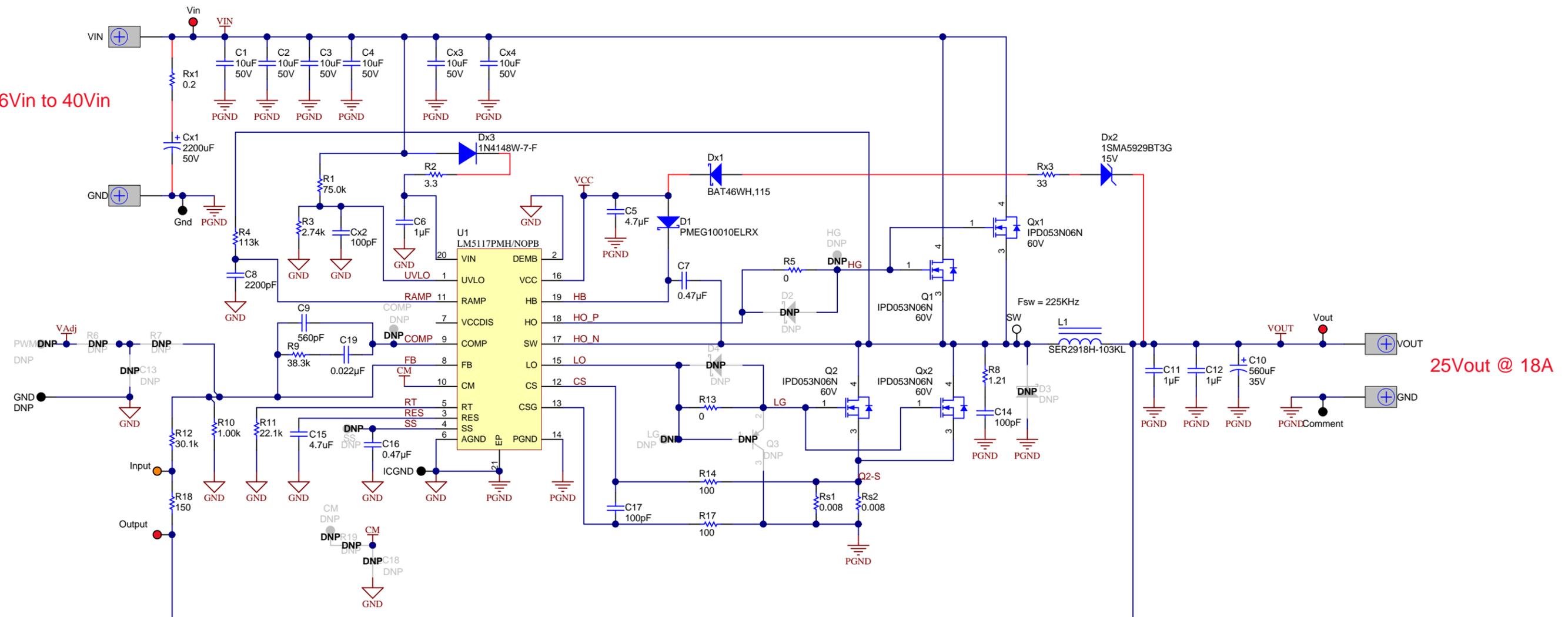


Input Voltage = 36Vin to 40Vin



**\*NOTES:**

1. All components with an "x" suffix are components that were not in the original design (i.e. do not have pads on the PCB) and were kluged into the circuit.
2. RED traces denote connections that were air-wired on the board, since there were not traces for these connections in the original PCB design.
3. Design is built on the PMP9280 PCB.

H1 1  
NY PMS 440 0025 PH

H2 1  
NY PMS 440 0025 PH

H3 1  
NY PMS 440 0025 PH

H4 1  
NY PMS 440 0025 PH

H5  
1902C

H6  
1902C

H7  
1902C

H8  
1902C

DNP  
FID1

DNP  
FID2

DNP  
FID3

!PCBA1  
PCB Assembly  
PMP9280 PCB

PCB  
LOGO  
FCC disclaimer

LBL1  
PCB Label  
Size: 0.65" x 0.20"

Variant/Label Table	
Variant	Label Text
001	

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Orderable: <a href="#">ChangeMe!</a>	Designed for:	Mod. Date: 3/6/2017
TID #: PMP20808	Project Title: LM25117 Synchronous Buck Converter	
Number: PMP20808	Rev: A	Sheet Title: Hardware
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 2
Drawn By:	File: PMP20808_EVM_Hardware.SchDoc	Size: B
Engineer: Hrag Kasparian	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	 TEXAS INSTRUMENTS <a href="http://www.ti.com">http://www.ti.com</a> © Texas Instruments 2016

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